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# Single low-ohmic 8-channel analog switch

Rev. 5 — 3 July 2012

Product data sheet

# 1. General description

The NX3L4051 is a low-ohmic 8-channel analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. The NX3L4051 has three digital select inputs (S1 to S3), eight independent inputs/outputs (Y0 to Y7) and a common input/output (Z). All eight switches share an enable input ( $\overline{E}$ ). A HIGH on  $\overline{E}$  causes all switches into the high impedance OFF-state, independent of Sn.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I<sub>CC</sub>. This makes it possible for the NX3L4051 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L4051 allows signals with amplitude up to V<sub>CC</sub> to be transmitted from Z to Yn or from Yn to Z. Its low ON resistance (0.5  $\Omega$ ) and flatness (0.13  $\Omega$ ) ensures minimal attenuation and distortion of transmitted signals.

# 2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
  - 1.7  $\Omega$  (typical) at V<sub>CC</sub> = 1.4 V
  - 1.0  $\Omega$  (typical) at V<sub>CC</sub> = 1.65 V
  - 0.6  $\Omega$  (typical) at V<sub>CC</sub> = 2.3 V
  - 0.5  $\Omega$  (typical) at V<sub>CC</sub> = 2.7 V
  - 0.5  $\Omega$  (typical) at V<sub>CC</sub> = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 7500 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
  - IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- 1.8 V control logic at V<sub>CC</sub> = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V<sub>CC</sub>
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



### Single low-ohmic 8-channel analog switch

# 3. Applications

- Cell phone
- PDA
- Portable media player
- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

# 4. Ordering information

Table 1. Ordering information

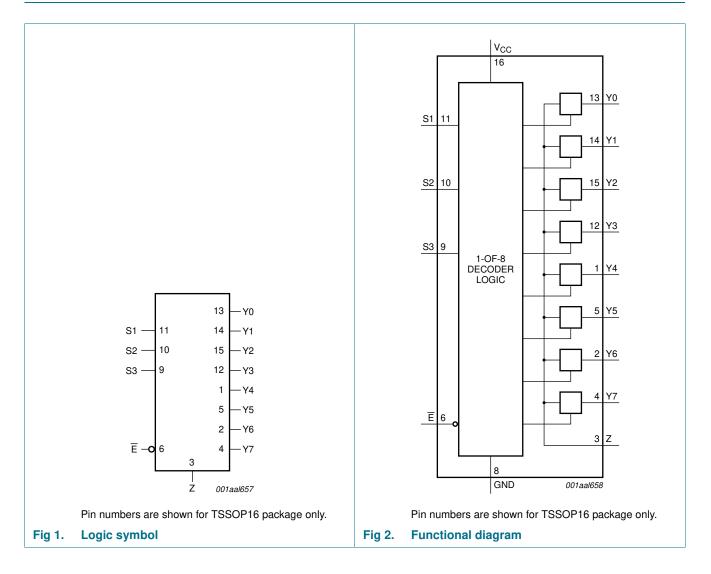
Type number	Package			
	Temperature range	Name	Description	Version
NX3L4051HR	–40 °C to +125 °C	HXQFN16	plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; body $3 \times 3 \times 0.5$ mm	SOT1039-2
NX3L4051PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

# 5. Marking

Table 2. Marking codes	
Type number	Marking code
NX3L4051HR	M41
NX3L4051PW	X3L4051

### Single low-ohmic 8-channel analog switch

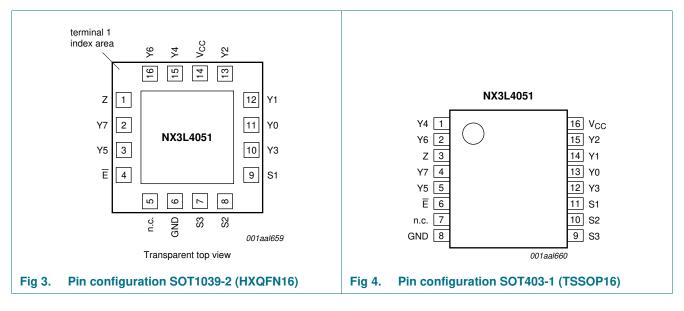
# 6. Functional diagram



Single low-ohmic 8-channel analog switch

# 7. Pinning information

# 7.1 Pinning



### 7.2 Pin description

Symbol	Pin		Description
	SOT1039-2	SOT403-1	
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	11, 12, 13, 10, 15, 3, 16, 2	13, 14, 15, 12, 1, 5, 2, 4	independent input or output
Z	1	3	independent output or input
Ē	4	6	enable input (active LOW)
n.c.	5	7	not connected
GND	6	8	ground (0 V)
S1, S2, S3	9, 8, 7	11, 10, 9	select input
V <sub>CC</sub>	14	16	supply voltage

#### Single low-ohmic 8-channel analog switch

#### **Functional description** 8.

Table 4.	Function table <sup>[1]</sup>			
Input				Channel ON
E	S3	S2	S1	
L	L	L	L	Y0 = Z
L	L	L	Н	Y1 = Z
L	L	Н	L	Y2 = Z
L	L	Н	Н	Y3 = Z
L	Н	L	L	Y4 = Z
L	Н	L	Н	Y5 = Z
L	Н	Н	L	Y6 = Z
L	Н	Н	Н	Y7 = Z
Н	Х	Х	Х	switches off

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

#### **Limiting values** 9.

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage	Sn and E	<u>[1]</u> –0.5	+4.6	V
V <sub>SW</sub>	switch voltage		2 -0.5	$V_{CC} + 0.5$	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{CC} + 0.5$ V	-	±50	mA
I <sub>SW</sub>	switch current	$V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; source or sink current	-	±350	mA
		$V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$			
		HXQFN16	<u>[3]</u>	250	mW
		TSSOP16	<u>[4]</u>	500	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not [2] exceed 4.6 V.

[3] For HXQFN16 package: above 135 °C the value of P<sub>tot</sub> derates linearly with 16.9 mW/K.

[4] For TSSOP16 package: above 60 °C the value of Ptot derates linearly with 5.5 mW/K above.

# **10. Recommended operating conditions**

Table 6.	Recommended operating con	ditions			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		1.4	4.3	V
VI	input voltage	Sn and $\overline{E}$	0	4.3	V
V <sub>SW</sub>	switch voltage		<u>[1]</u> 0	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	Sn and $\overline{E}$ ; V <sub>CC</sub> = 1.4 V to 4.3 V	-	200	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

# 11. Static characteristics

#### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V <sub>IH</sub>	HIGH-level	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	0.9	-	-	0.9	-	-	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	0.9	-	-	0.9	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.1	-	-	1.1	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	1.3	-	-	1.3	-	-	V
		V <sub>CC</sub> = 3.6 V to 4.3 V	1.4	-	-	1.4	-	-	V
V <sub>IL</sub>	LOW-level	$V_{CC} = 1.4 \text{ V}$ to 1.6 V	-	-	0.3	-	0.3	0.3	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	0.4	-	0.4	0.3	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.4	-	0.4	0.4	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.5	-	0.5	0.5	V
		$V_{CC} = 3.6 \text{ V} \text{ to } 4.3 \text{ V}$	-	-	0.6	-	0.6	0.6	V
II	input leakage current	Sn and $\overline{E}$ ; V <sub>I</sub> = GND to 4.3 V; V <sub>CC</sub> = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μA
I <sub>S(OFF)</sub>	OFF-state	Yn ports; see <u>Figure 5</u>							
	leakage	$V_{CC} = 1.4 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
	current	$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	-	±10	-	±50	±500	nA
I <sub>S(ON)</sub>	ON-state leakage current	Z port; $V_{CC} = 1.4 V$ to 3.6 V; see <u>Figure 6</u>							
		$V_{CC} = 1.4 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	±20	-	±200	±2000	nA
		$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	-	±40	-	±200	±2000	nA
I <sub>CC</sub>	supply current								
		$V_{CC} = 3.6 V$	-	-	100	-	500	5000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	6000	nA
NX3L4051		All information provided in this d	ocument is subje	ct to legal discl	aimers.		© NXP	B.V. 2012. All righ	ts reserved

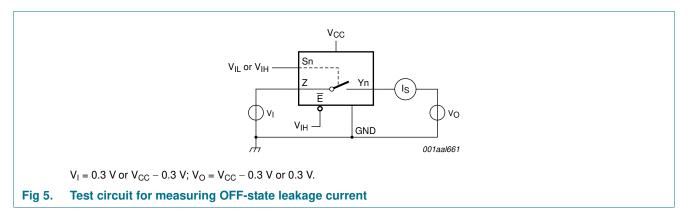
### Single low-ohmic 8-channel analog switch

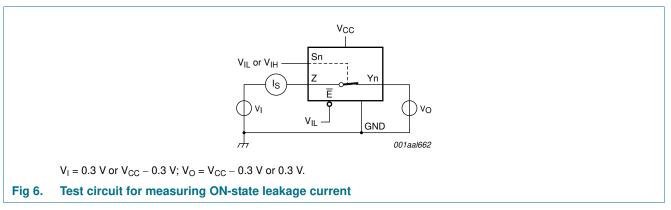
Symbol Parameter		Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
		Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)		
$\Delta I_{CC}$	additional	$V_{SW} = GND \text{ or } V_{CC}$							
	supply current	$V_1 = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μA
		$V_1 = 2.6 V; V_{CC} = 3.6 V$	-	0.35	0.7	-	1	1	μA
		$V_{I} = 1.8 V; V_{CC} = 4.3 V$	-	7.0	10.0	-	15	15	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	2.5	4.0	-	5	5	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$	-	50	200	-	300	500	nA
CI	input capacitance	Sn and $\overline{E}$	-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	35	-	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance		-	350	-	-	-	-	pF

#### Static characteristics ... continued Table 7.

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

# 11.1 Test circuits





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### 11.2 ON resistance

#### Table 8. ON resistance<sup>[1]</sup>

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 14.

Symbol	Parameter	Conditions	T <sub>amb</sub> =	-40 °C to	o +85 °C	$T_{amb} = -40 \circ$	C to +125 °C	Unit
			Min	Typ[2]	Max	Min	Max	
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = GND$ to $V_{CC}$ ; $I_{SW} = 100$ mA; see Figure 7						
		$V_{CC} = 1.4 V$	-	1.7	3.7	-	4.1	Ω
		$V_{CC} = 1.65 V$	-	1.0	1.6	-	1.7	Ω
		$V_{CC} = 2.3 V$	-	0.6	0.8	-	0.9	Ω
		$V_{CC} = 2.7 V$	-	0.5	0.75	-	0.9	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.75	-	0.9	Ω
$\Delta R_{ON}$	ON resistance mismatch	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	3]					
	between channels	$V_{CC} = 1.4 \text{ V}; V_{SW} = 0.4 \text{ V}$	-	0.18	0.30	-	0.30	Ω
	channels	$V_{CC}$ = 1.65 V; $V_{SW}$ = 0.5 V	-	0.18	0.20	-	0.30	Ω
		$V_{CC}$ = 2.3 V; $V_{SW}$ = 0.7 V	-	0.07	0.10	-	0.13	Ω
		$V_{CC} = 2.7 \text{ V}; V_{SW} = 0.8 \text{ V}$	-	0.07	0.10	-	0.13	Ω
		$V_{CC} = 4.3 \text{ V}; V_{SW} = 0.8 \text{ V}$	-	0.07	0.10	-	0.13	Ω
R <sub>ON(flat)</sub>	ON resistance (flatness)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	<u>4]</u>					
		$V_{CC} = 1.4 V$	-	1.0	3.3	-	3.6	Ω
		V <sub>CC</sub> = 1.65 V	-	0.5	1.2	-	1.3	Ω
		$V_{CC} = 2.3 V$	-	0.15	0.3	-	0.35	Ω
		$V_{CC} = 2.7 V$	-	0.13	0.3	-	0.35	Ω
		$V_{CC} = 4.3 V$	-	0.2	0.4	-	0.45	Ω

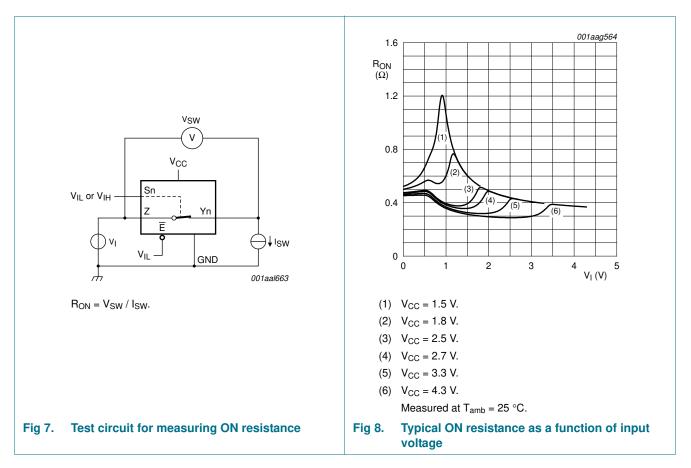
[1] For NX3L4051PW (TSSOP16 package), all ON resistance values are up to 0.05  $\Omega$  higher.

[2] Typical values are measured at  $T_{amb} = 25 \text{ °C}$ .

[3] Measured at identical V<sub>CC</sub>, temperature and input voltage.

[4] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

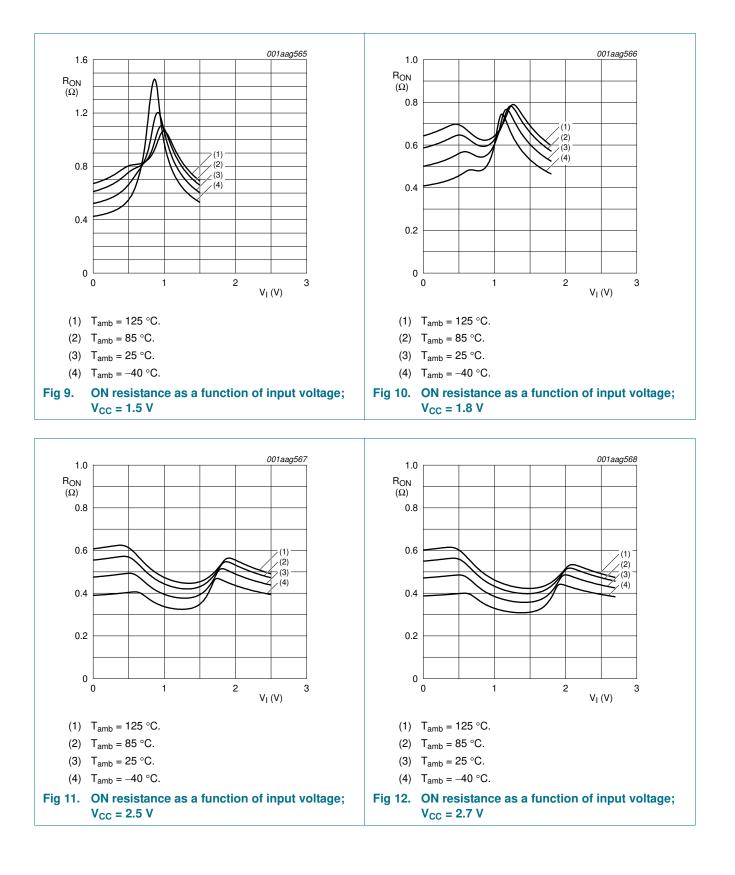
### Single low-ohmic 8-channel analog switch



## 11.3 ON resistance test circuit and graphs

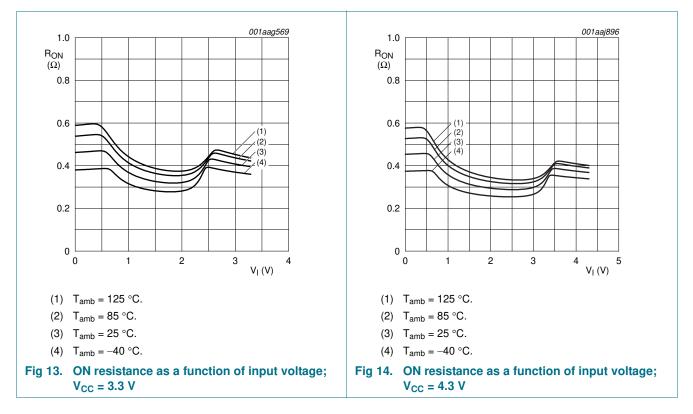
# NX3L4051

### Single low-ohmic 8-channel analog switch



# NX3L4051

### Single low-ohmic 8-channel analog switch



# 12. Dynamic characteristics

#### Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	-
t <sub>en</sub>	enable time	Ē, Sn to Z or Yn; see <u>Figure 15</u>							
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	45	100	-	120	125	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	32	75	-	85	95	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	21	50	-	55	60	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	19	45	-	45	50	ns
		$V_{CC} = 3.6 \text{ V} \text{ to } 4.3 \text{ V}$	-	19	45	-	45	50	ns
t <sub>dis</sub>	disable time	Ē, Sn to Z or Yn; see <u>Figure 15</u>							
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	25	80	-	90	105	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	15	65	-	70	75	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	9	30	-	35	40	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	8	25	-	30	35	ns
		$V_{CC}$ = 3.6 V to 4.3 V	-	8	25	-	30	35	ns

#### Single low-ohmic 8-channel analog switch

#### T<sub>amb</sub> = -40 °C to +125 °C Symbol Parameter Conditions T<sub>amb</sub> = 25 °C Unit Min Typ<sup>[1]</sup> Max Min Max Max (85 °C) (125 °C) [2] break-before-make see Figure 16 t<sub>b-m</sub> time $V_{CC} = 1.4 \text{ V}$ to 1.6 V 9 \_ 19 \_ \_ ns \_ V<sub>CC</sub> = 1.65 V to 1.95 V 17 7 ns ---- $V_{CC} = 2.3 \text{ V}$ to 2.7 V 12 4 \_ \_ \_ ns \_ $V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$ 10 3 \_ \_ \_ ns \_ $V_{CC} = 3.6 V \text{ to } 4.3 V$ 9 2 --ns -

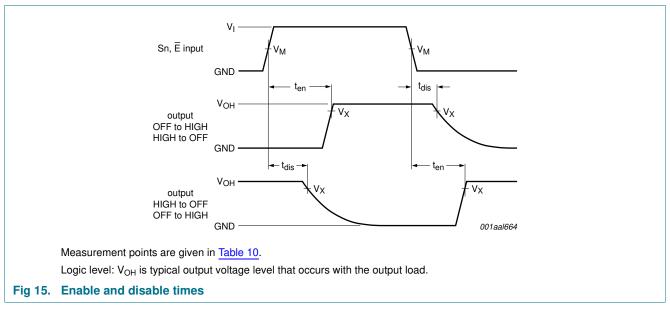
#### Dynamic characteristics ... continued Table 9.

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

[1] Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.5$  V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

Break-before-make guaranteed by design. [2]

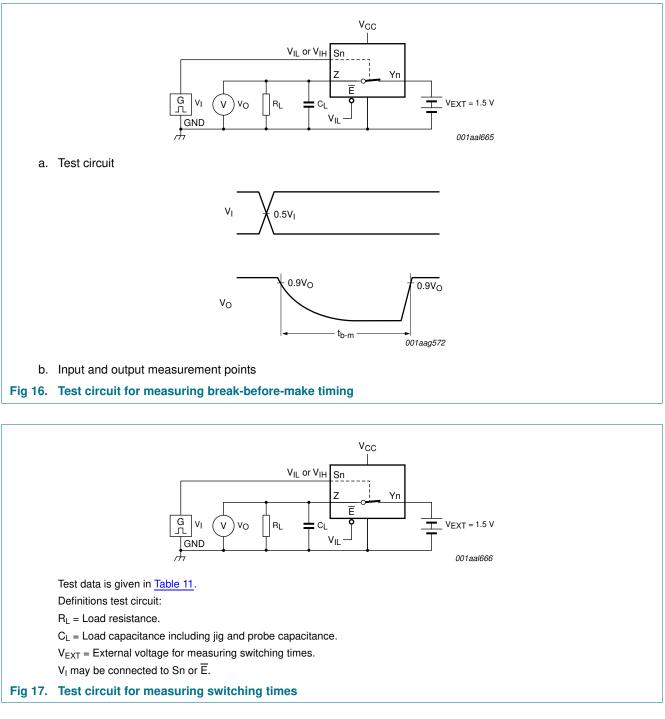
## 12.1 Waveform and test circuits



#### Table 10. Measurement points

Supply voltage	Input	Output
V <sub>CC</sub>	V <sub>M</sub>	V <sub>X</sub>
1.4 V to 4.3 V	0.5V <sub>CC</sub>	0.9V <sub>OH</sub>

### Single low-ohmic 8-channel analog switch



#### Table 11. Test data

Supply voltage	Input		Load	
V <sub>cc</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL
1.4 V to 4.3 V	V <sub>CC</sub>	$\leq$ 2.5 ns	35 pF	50 Ω

## 12.2 Additional dynamic characteristics

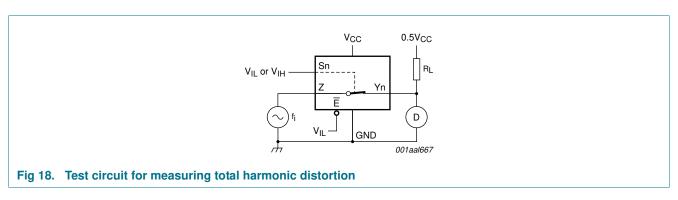
#### Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I = GND$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 2.5$  ns;  $T_{amb} = 25$  °C.

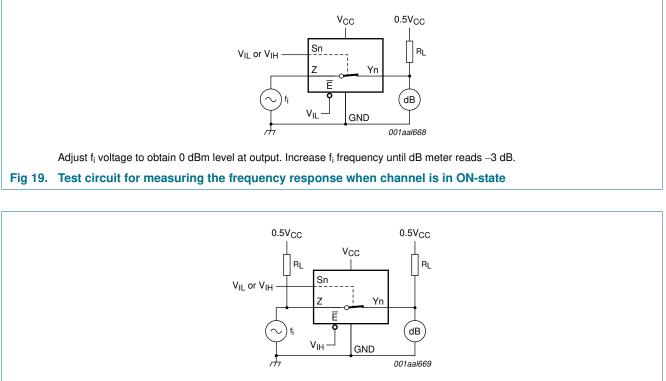
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD	total harmonic distortion	$f_i$ = 20 Hz to 20 kHz; $R_L$ = 32 $\Omega$ ; see Figure 18	<u>[1]</u>			
		$V_{CC} = 1.4 \text{ V}; \text{ V}_{I} = 1 \text{ V} (p-p)$	-	0.15	-	%
		V <sub>CC</sub> = 1.65 V; V <sub>I</sub> = 1.2 V (p-p)	-	0.10	-	%
		V <sub>CC</sub> = 2.3 V; V <sub>I</sub> = 1.5 V (p-p)	-	0.02	-	%
		V <sub>CC</sub> = 2.7 V; V <sub>1</sub> = 2 V (p-p)	-	0.02	-	%
		V <sub>CC</sub> = 4.3 V; V <sub>I</sub> = 2 V (p-p)	-	0.02	-	%
f <sub>(-3dB)</sub>	–3 dB frequency response	$R_L = 50 \Omega$ ; see Figure 19	<u>[1]</u>			
		V <sub>CC</sub> = 1.4 V to 4.3 V	-	15	-	MHz
$\alpha_{iso}$	isolation (OFF-state)	$f_i = 100 \text{ kHz}; \text{ R}_L = 50 \Omega; \text{ see } \frac{\text{Figure 20}}{100 \text{ kHz}}$	<u>[1]</u>			
		V <sub>CC</sub> = 1.4 V to 4.3 V	-	-90	-	dB
V <sub>ct</sub>	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$ ; $C_L = 50 \text{ pF}$ ; $R_L = 50 \Omega$ ; see Figure 21				
		V <sub>CC</sub> = 1.4 V to 3.6 V	-	0.2	-	V
		V <sub>CC</sub> = 3.6 V to 4.3 V	-	0.3	-	V
Xtalk	crosstalk	between switches; $f_i = 100 \text{ kHz}$ ; $R_L = 50 \Omega$ ; see <u>Figure 22</u>	[1]			
		V <sub>CC</sub> = 1.4 V to 4.3 V	-	-90	-	dB
Q <sub>inj</sub>	charge injection	$      f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; \\ R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure 23}}{2}      $				
		$V_{CC} = 1.5 V$	-	3	-	рС
		V <sub>CC</sub> = 1.8 V	-	4	-	рС
		$V_{CC} = 2.5 V$	-	6	-	рС
		$V_{CC} = 3.3 V$	-	9	-	рС
		$V_{CC} = 4.3 V$	-	15	-	рС

[1]  $f_i$  is biased at 0.5V<sub>CC</sub>.

# 12.3 Test circuits



#### Single low-ohmic 8-channel analog switch

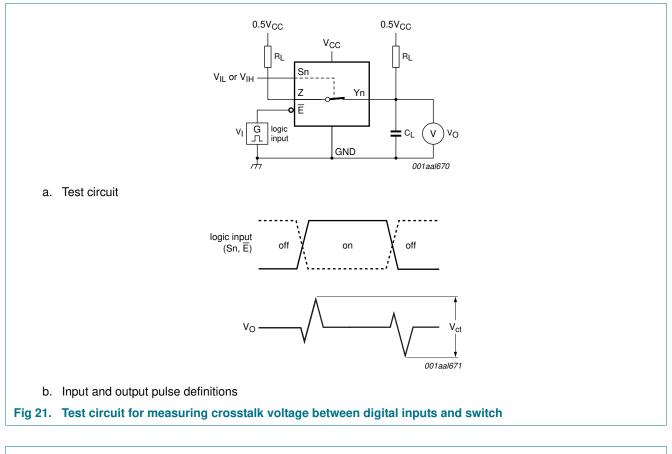


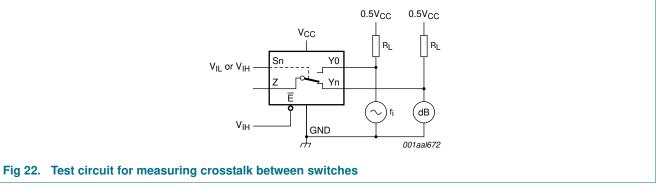
Adjust f<sub>i</sub> voltage to obtain 0 dBm level at input.

Fig 20. Test circuit for measuring isolation (OFF-state)

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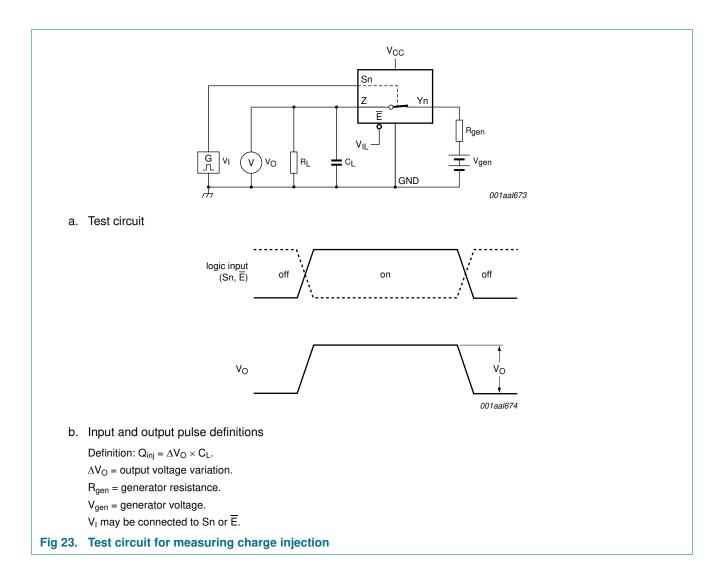
### Single low-ohmic 8-channel analog switch





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### Single low-ohmic 8-channel analog switch

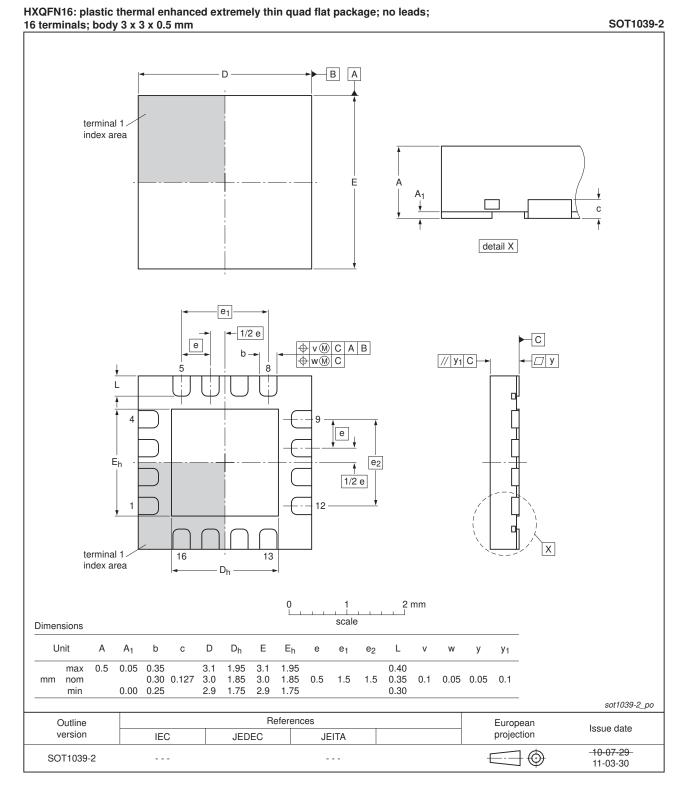


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#### Single low-ohmic 8-channel analog switch

# 13. Package outline



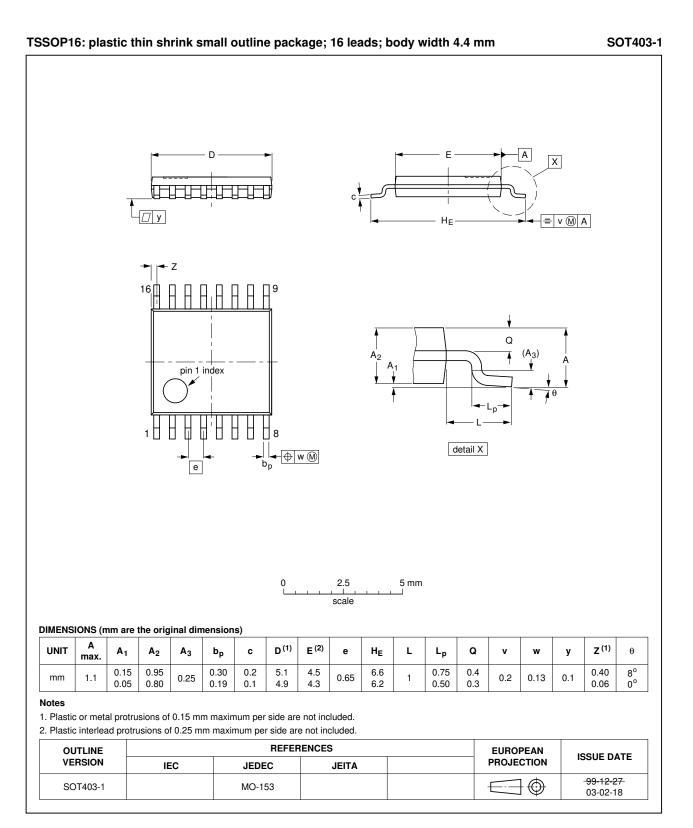
#### Fig 24. Package outline SOT1039-2 (HXQFN16)

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#### Fig 25. Package outline SOT403-1 (TSSOP16)

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# 14. Abbreviations

AcronymDescriptionCDMCharged Device ModelCMOSComplementary Metal-Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body ModelMMMachine ModelPDAPersonal Digital Assistant	Table 13. Abbreviations			
CMOSComplementary Metal-Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body ModelMMMachine Model	Acronym	Description		
ESDElectroStatic DischargeHBMHuman Body ModelMMMachine Model	CDM	Charged Device Model		
HBM     Human Body Model       MM     Machine Model	CMOS	Complementary Metal-Oxide Semiconductor		
MM Machine Model	ESD	ElectroStatic Discharge		
	HBM	Human Body Model		
PDA Personal Digital Assistant	MM	Machine Model		
	PDA	Personal Digital Assistant		

# 15. Revision history

Table 14. Revision	n history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L4051 v.5	20120703	Product data sheet	-	NX3L4051 v.4
Modifications:	<ul> <li>For type nu</li> </ul>	mber NX3L4051HR the sot	code has changed to SC	DT1039-2.
NX3L4051 v.4	20111107	Product data sheet	-	NX3L4051 v.3
Modifications:	<ul> <li>Legal page</li> </ul>	s updated.		
NX3L4051 v.3	20101222	Product data sheet	-	NX3L4051 v.2
NX3L4051 v.2	20100812	Product data sheet	-	NX3L4051 v.1
NX3L4051 v.1	20100415	Product data sheet	-	-

# 16. Legal information

### 16.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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